



## Material declaration form

General Information			
IPC	1752	Version	2
Form type*	Distribute		
Sectionals*	Material information	Subsectionals*	A-D
	Manufacturing information		

Supplier Information			
Company name*	STMicroelectronics	Response Date*	2025-03-06
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact phone*	Refer to Supplier Comment section	Contact email*	Refer to Supplier Comment section
Authorized representative*	MDG CHAMPION	Representative title	MDGMaterial Declaration champion
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section
Supplier comment	Online Technical Support - STMicroelectronics : <a href="http://www.st.com/web/en/support/support.html">http://www.st.com/web/en/support/support.html</a>		

**Uncertainty statement**

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**Legal statement**

Supplier acceptance*	true	Legal declaration*	Standard
Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.			



Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
STM32U083CCT6	615B*489XXXA	A	998Z	2025-03-06
	Amount	Unit of measure	Unit type	ST ECOPACK grade
	177	mg	Each	ECOPACK® 2

Manufacturing information				
J-STD-020 MSL rating	Classification temperature	Number of reflow cycles		
3	260	3		
Bulk solder termination	Terminal plating	Terminal base alloy	Comment	
Not Applicable	Tin (Sn), matte, annealed	Copper Alloy	0	
Package designator	Package size	Number of instances	Shape	
QFP	7x7	48	Gull wing	
Comment	Package : 5B LQFP 48 7x7x1.4 1 0110596			

QueryList : RoHS Directive 2011/65/EU - 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015		Response
1 - Product(s) meets EU RoHS requirement without any exemptions		true
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)		false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions		false
Exemption Id.	Description	
,		

QueryList : REACH-21st January 2025				Response
QUERY				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
,	#N/A			



Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document						Mfr Item Name	615B*489XXXA		177.4608		6000000.0	1000000.0				
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)				
Die or dies	M-011 Other inorganic materials	7.641	mg	supplier	die	Silicon (Si)	7440-21-3		6.967	mg	911738	45206.29				
				supplier	metallization	Aluminium (Al)	7429-90-5		0.031	mg	4032	199.92				
				supplier	metallization	Copper (Cu)	7440-50-8		0.288	mg	37634	1865.99				
				supplier	metallization	Tantalum (Ta)	7440-25-7		0.092	mg	12097	599.80				
				supplier	metallization	Titanium (Ti)	7440-32-6		0.003	mg	448	22.21				
				supplier	metallization	Tungsten (W)	7440-33-7		0.003	mg	448	22.21				
				supplier	Passivation	Silicon Nitride	12033-89-5		0.072	mg	9409	466.52				
				supplier	Passivation	Silicon Oxide	7631-86-9		0.185	mg	24194	1199.60				
				Glue epoxy (EN4900GC)	Other Organic Materials	0.427	mg	supplier	Organic Compounds	Acrylic resin	Proprietary		0.030	mg	70000	200.45
								supplier	Organic Compounds	Polybutadiene derivative	Proprietary		0.009	mg	20000	57.27
supplier	Organic Compounds	Butadiene copolymer	Proprietary						0.006	mg	15000	42.95				
supplier	Organic Compounds	Acrylate	Proprietary						0.023	mg	54000	154.64				
supplier	Organic Compounds	Epoxy resin	Proprietary						0.013	mg	30000	85.91				
supplier	Organic Compounds	Peroxide	Proprietary						0.003	mg	8000	22.91				
supplier	Organic Compounds	Additive	Proprietary						0.008	mg	18000	51.55				
supplier	Metals	Silver	7440-22-4						0.335	mg	785000	2247.95				
Encapsulation (EME-G700LAL-A )	Other Organic Materials	117.000	mg	supplier	Organic Compounds	Epoxy Resin	Proprietary		6.435	mg	55000	35930.03				
				supplier	Organic Compounds	Phenol Resin	Proprietary		2.457	mg	21000	13718.74				
				supplier	Glass	Silica(Amorphous)A	60676-86-0		93.600	mg	800000	522618.66				
				supplier	Glass	Silica(Amorphous)B	7631-86-9		13.923	mg	119000	77739.53				
Bonding Wire (Cu)	Bonding Wire	0.314	mg	supplier	Organic Compounds	Carbon Black	1333-86-4		0.585	mg	5000	3266.37				
				supplier	Metals	Copper	7440-50-8		0.304	mg	965500	1546.32				
				supplier	Metals	Palladium	7440-05-3		0.010	mg	31000	49.65				
Plating anode (Sn)	Other inorganic materials	1.078	mg	supplier	Metals	Gold	7440-57-5		0.001	mg	3500	5.61				
				supplier	Metals	Tin	7440-31-5		1.078	mg	1000000	6060.54				
Leadframe (C194 + Ag)	Copper & its alloys	51.000	mg	supplier	Metals	Copper	7440-50-8		49.595	mg	972450	278722.04				
				supplier	Metals	Iron	7439-89-6		1.153	mg	22600	6477.58				
				supplier	Metals	Zinc	7440-66-6		0.077	mg	1500	429.93				
				supplier	Metals	Phosphorus	7723-14-0		0.015	mg	300	85.99				
				supplier	Metals	Silver	7440-22-4		0.158	mg	3100	888.52				
				SVHC	Metals	Lead	7439-92-1		0.003	mg	50	14.33				